© Copyright 2005. IPC	© Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
	IPC Web Site for Information on IPC-1752 Standard Form				 * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg 					Ifg Informati	on			
Supplier Information														
Company name* Con			Company unique ID			Unique ID Authority					Response Date*			
onsemi										2025-0	2025-05-13			
ontact Name Title - Contact					Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards Product Envir			nviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Represe			sentative		Phone - Representative*			Email ·	Email - Representative*					
Product-Env-Stewards Produc			roduct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Requester Item Number Mfr Item N		Number Mfr Item Name			Effective Date	e Version		Manufacturing Site		Weight*	UOM	Unit Type	
	NTBG02	NTBG022N120M3S SiC MOS D2PA		K-7L 22mohm 1	. 22mohm 1200V 2				СРА		1576.704	mg	Each	
Manufacturing Proccess Information	on											·	·	
Terminal Plating / Grid Array Mate	ninal Plating / Grid Array Material Terminal Base Alloy		Alloy	J-STD-020 MSI	L Rating	Peak Pro	cess Body T	'emperatu	re Max Time at Pea	k Tempera	ture Numb	er of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy			1		245		С	30	seco	nds 3				
Comments														
level 1 - maximum time at peak temperature	e during sol	dering is 10-3	0 seconds											
or more information regarding material co	mposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	5.29	mg	Supplier	Silicon Carbide	409-21-2		5.29	mg	
Die Attach Solder	7.49	mg	Supplier	Silver (Ag)	7440-22-4		0.1873	mg	
			А	Lead (Pb)	7439-92-1	7a	7.1529	mg	
			Supplier	Tin (Sn)	7440-31-5		0.1498	mg	
Lead Frame	921.0	mg	В	Nickel (Ni)	7440-02-0		9.21	mg	
			Supplier	Copper (Cu)	7440-50-8		911.79	mg	
Mold Compound-Black	626.0	mg		Epoxy resin	proprietary data		18.78	mg	
			Supplier	Phenolic Resin	Proprietary Data		9.39	mg	
			Supplier	Silica Amorphous (SiO2)	7631-86-9		93.9	mg	
			Supplier	Carbon Black (C)	1333-86-4		3.13	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		500.8	mg	
Plating	0.224	mg	Supplier	Tin (Sn)	7440-31-5		0.224	mg	
Wire Bond - Al	16.7	mg	Supplier	Aluminum (Al)	7429-90-5		16.7	mg	